



### CST4614 N-Ch and P-Ch Fast Switching MOSFETs

- ★ Green Device Available
- ★ Super Low Gate Charge
- ★ Excellent CdV/dt effect decline
- ★ Advanced high cell density Trench technology

#### CST4614 Product Summary

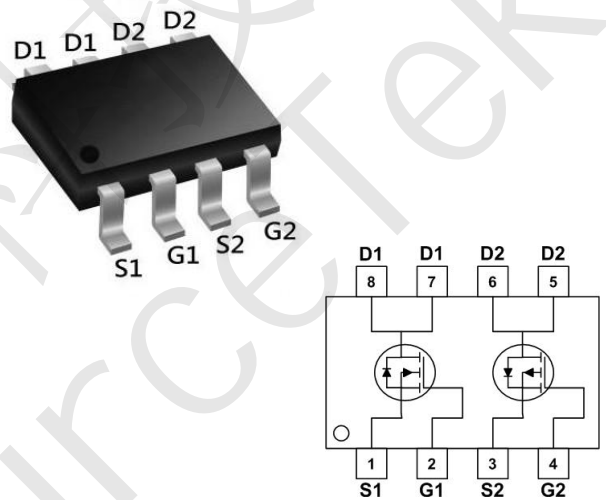


BVDSS	RDSON	ID
40V	17mΩ	8.5A
-40V	39mΩ	-7.5A

#### CST4614 Description

The CST4614 is the high performance complementary N-ch and P-ch MOSFETs with high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications. The CST4614 meet the RoHS and Green

#### CST4614 SOP8 Pin Configurations



#### CST4614 Absolute Maximum Ratings (T<sub>A</sub>=25°C unless otherwise specified)

Symbol	Parameter	Max. N-Channel	Max. P-Channel	Units	
V <sub>DSS</sub>	Drain-Source Voltage	40	-40	V	
V <sub>GSS</sub>	Gate-Source Voltage	±20	±20	V	
I <sub>D</sub>	Continuous Drain Current	T <sub>A</sub> = 25°C	8.5	-7.5	A
		T <sub>A</sub> = 100°C	5.2	-3.9	A
I <sub>DM</sub>	Pulsed Drain Current <sup>note1</sup>	32	-24	A	
E <sub>AS</sub>	Single Pulsed Avalanche Energy <sup>note2</sup>	13	17.6	mJ	
P <sub>D</sub>	Power Dissipation	2	3.2	W	
R <sub>θJA</sub>	Thermal Resistance, Junction to Ambient	62.5	39	°C/W	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range	-55 to +150		°C	



### CST4614 N-Ch and P-Ch Fast Switching MOSFETs

#### CST4614 N-Channel Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
<b>Off Characteristic</b>						
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	40	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =40V, V <sub>GS</sub> =0V	-	-	1.0	μA
I <sub>GSS</sub>	Gate to Body Leakage Current	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V	-	-	±100	nA
<b>On Characteristics</b>						
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	1.0	1.5	2.5	V
R <sub>DS(on)</sub>	Static Drain-Source on-Resistance note3	V <sub>GS</sub> =10V, I <sub>D</sub> =8A	-	17	22	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =5A	-	25	35	mΩ
<b>Dynamic Characteristics</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =20V, V <sub>GS</sub> =0V, f=1.0MHz	-	633	-	pF
C <sub>oss</sub>	Output Capacitance		-	67	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		-	58	-	pF
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> =20V, I <sub>D</sub> =8A, V <sub>GS</sub> =10V	-	12	-	nC
Q <sub>gs</sub>	Gate-Source Charge		-	3.2	-	nC
Q <sub>gd</sub>	Gate-Drain("Miller") Charge		-	3.1	-	nC
<b>Switching Characteristics</b>						
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>DD</sub> = 20V, R <sub>L</sub> =2.5Ω V <sub>GS</sub> =10V, R <sub>REN</sub> =3Ω	-	4	-	ns
t <sub>r</sub>	Turn-on Rise Time		-	3	-	ns
t <sub>d(off)</sub>	Turn-off Delay Time		-	15	-	ns
t <sub>f</sub>	Turn-off Fall Time		-	2	-	ns
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
I <sub>S</sub>	Maximum Continuous Drain to Source Diode Forward Current		-	-	8.5	A
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		-	-	32	A
V <sub>SD</sub>	Drain to Source Diode Forward Voltage	V <sub>GS</sub> =0V, I <sub>S</sub> = 8A	-	-	1.2	V

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

2. EAS condition : T<sub>J</sub>=25°C, V<sub>DD</sub>=20V, V<sub>G</sub>=10V, L=0.5mH, R<sub>g</sub>=25Ω, I<sub>AS</sub>=7.2A

T<sub>J</sub>=25°C, V<sub>DD</sub>=-20V, V<sub>G</sub>= -10V, L=0.5mH, R<sub>g</sub>=25Ω, I<sub>AS</sub>=-8.4A

3. Pulse Test: Pulse Width≤300μs, Duty Cycle≤2%



### CST4614 N-Ch and P-Ch Fast Switching MOSFETs

#### CST4614 P-Channel Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
<b>Off Characteristic</b>						
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> = -250μA	-40	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = -40V, V <sub>GS</sub> =0V	-	-	-1	μA
I <sub>GSS</sub>	Gate to Body Leakage Current	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V	-	-	±100	nA
<b>On Characteristics</b>						
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> = -250μA	-1.0	-1.6	-2.5	V
R <sub>DS(on)</sub>	Static Drain-Source on-Resistance <small>note3</small>	V <sub>GS</sub> = -10V, I <sub>D</sub> = -6A	-	39	53	mΩ
		V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -4A	-	58	81	
<b>Dynamic Characteristics</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = -20V, V <sub>GS</sub> =0V, f=1.0MHz	-	860	-	pF
C <sub>oss</sub>	Output Capacitance		-	87	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		-	70	-	pF
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> = -20V, I <sub>D</sub> = -6A, V <sub>GS</sub> = -10V	-	13	-	nC
Q <sub>gs</sub>	Gate-Source Charge		-	3.8	-	nC
Q <sub>gd</sub>	Gate-Drain("Miller") Charge		-	3.1	-	nC
<b>Switching Characteristics</b>						
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>DD</sub> = -20V, R <sub>L</sub> =2.3Ω V <sub>GS</sub> =-10V, R <sub>REN</sub> =6Ω	-	7.5	-	ns
t <sub>r</sub>	Turn-on Rise Time		-	5.5	-	ns
t <sub>d(off)</sub>	Turn-off Delay Time		-	19	-	ns
t <sub>f</sub>	Turn-off Fall Time		-	7	-	ns
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
I <sub>S</sub>	Maximum Continuous Drain to Source Diode Forward Current		-	-	-7.5	A
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		-	-	-24	A
V <sub>SD</sub>	Drain to Source Diode Forward Voltage	V <sub>GS</sub> =0V, I <sub>S</sub> = -6A	-	-	-1.2	V



## CST4614 Typical Performance Characteristics-N

Figure 1: Output Characteristics

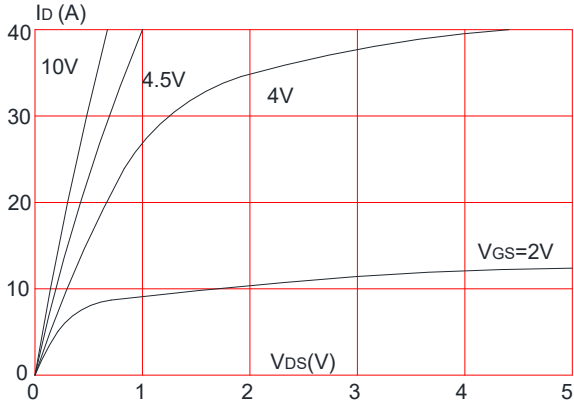


Figure 2: Typical Transfer Characteristics

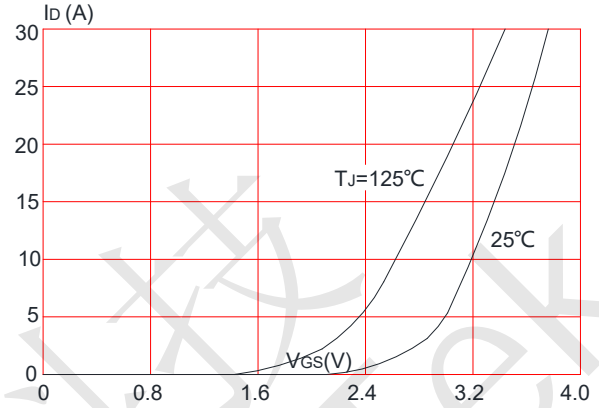


Figure 3: On-resistance vs. Drain Current

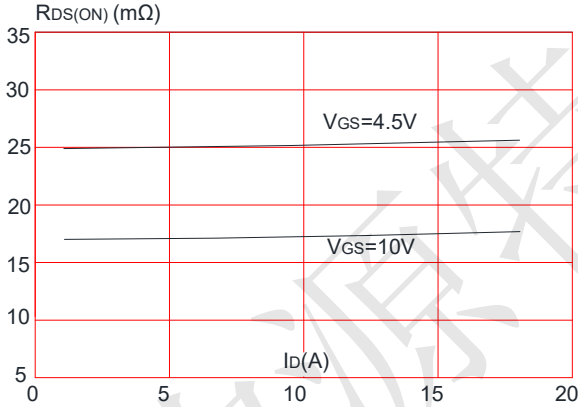


Figure 4: Body Diode Characteristics

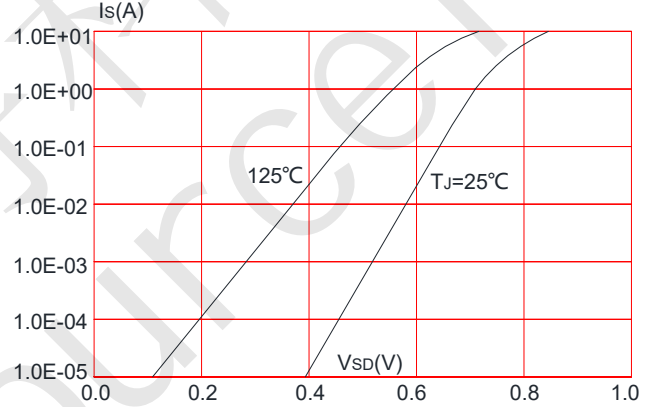


Figure 5: Gate Charge Characteristics

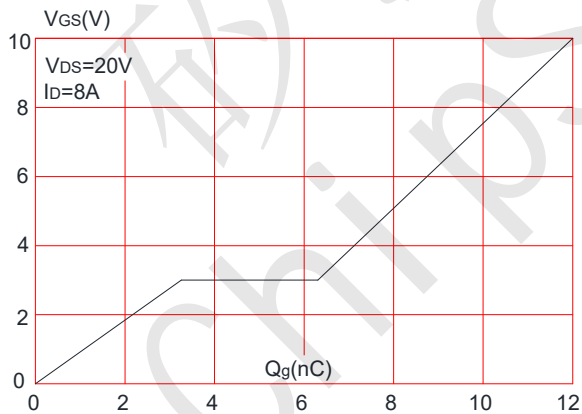
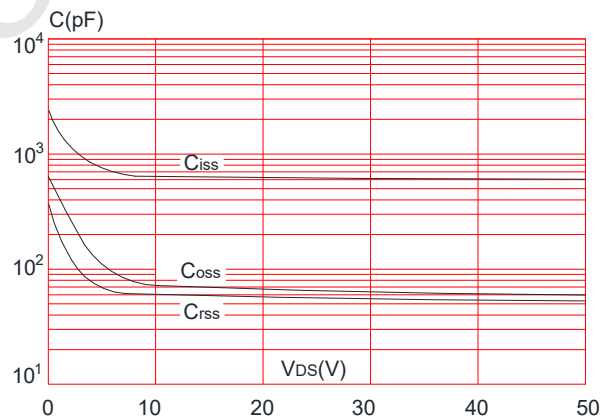


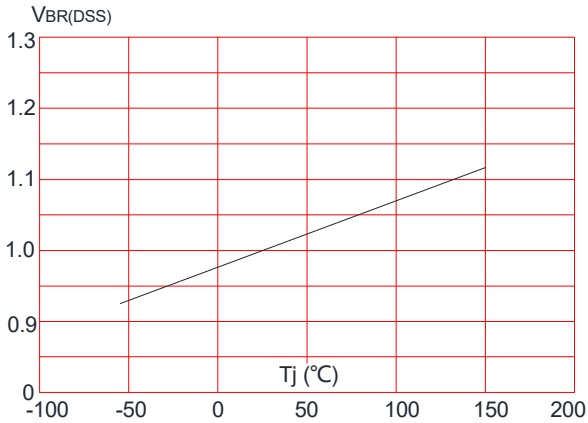
Figure 6: Capacitance Characteristics



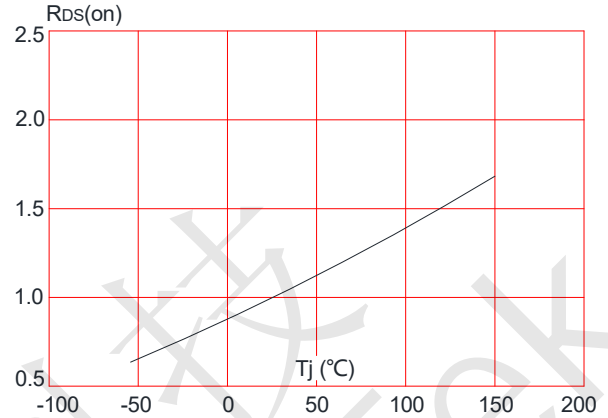


### CST4614 N-Ch and P-Ch Fast Switching MOSFETs

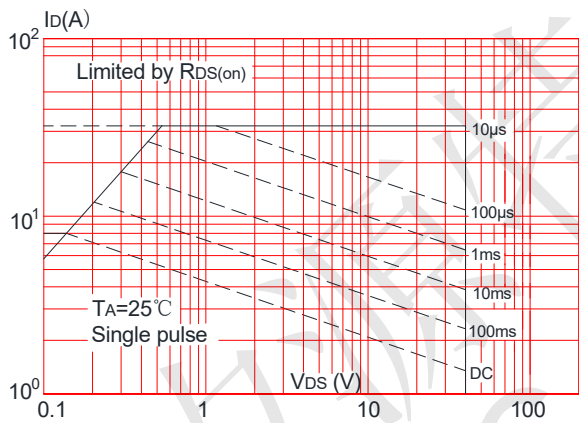
**Figure 7:** Normalized Breakdown Voltage vs. Junction Temperature



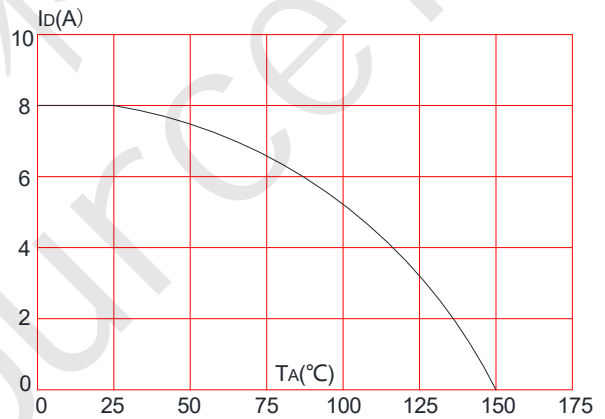
**Figure 8:** Normalized on Resistance vs. Junction Temperature



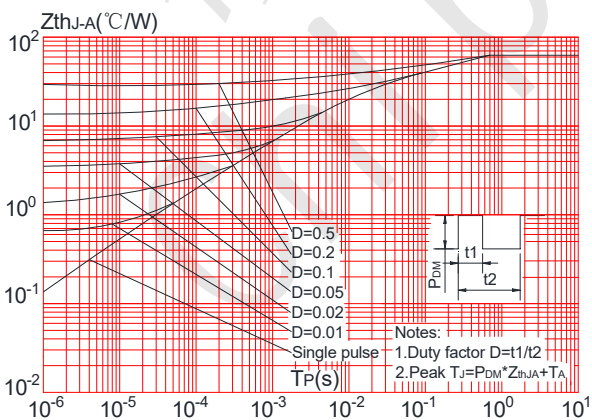
**Figure 9:** Maximum Safe Operating Area



**Figure 10:** Maximum Continuous Drain Current vs. Ambient Temperature



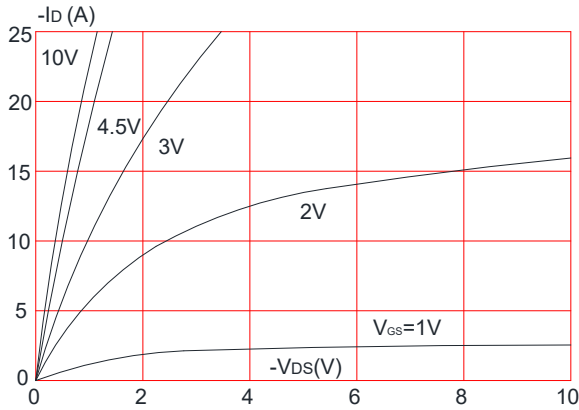
**Figure.11:** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



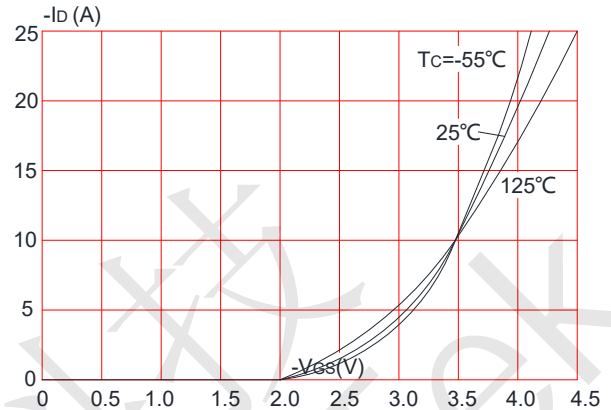


## CST4614 Typical Performance Characteristics-P

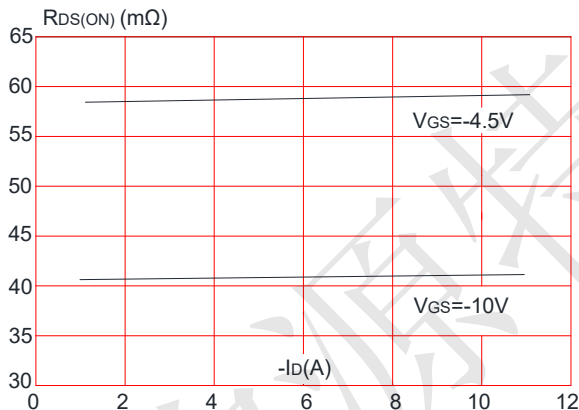
**Figure 1: Output Characteristics**



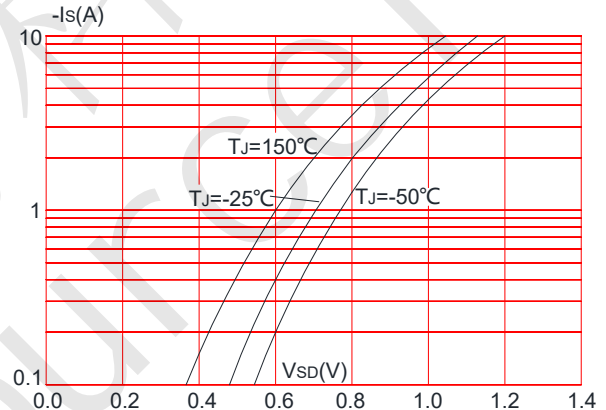
**Figure 2: Typical Transfer Characteristics**



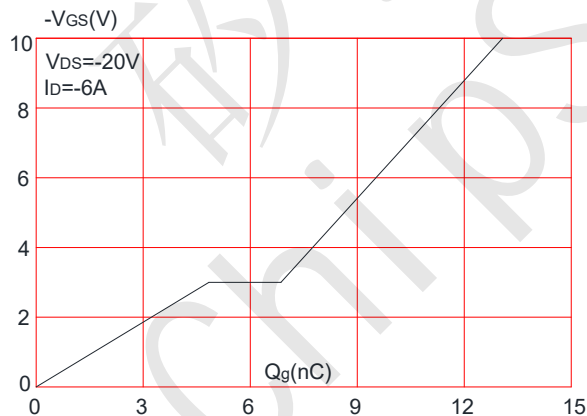
**Figure 3: On-resistance vs. Drain Current**



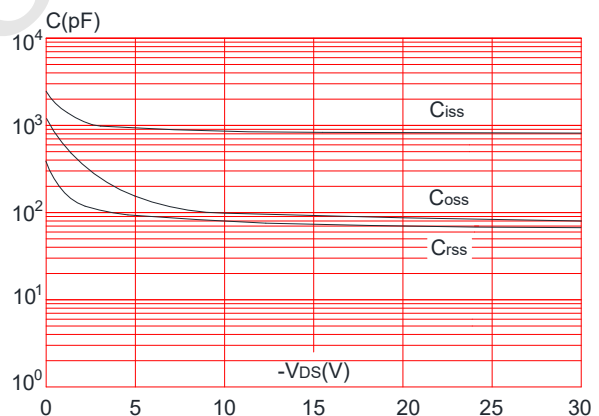
**Figure 4: Body Diode Characteristics**



**Figure 5: Gate Charge Characteristics**



**Figure 6: Capacitance Characteristics**

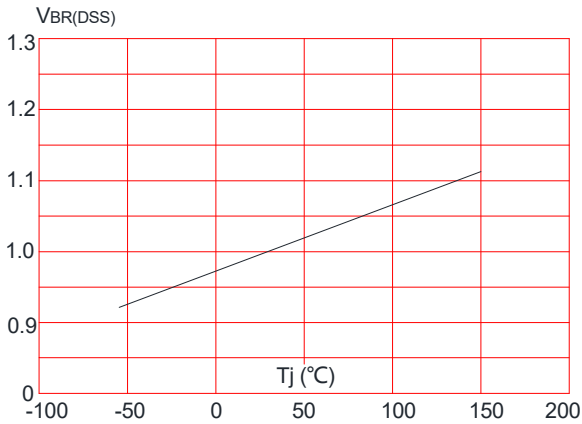




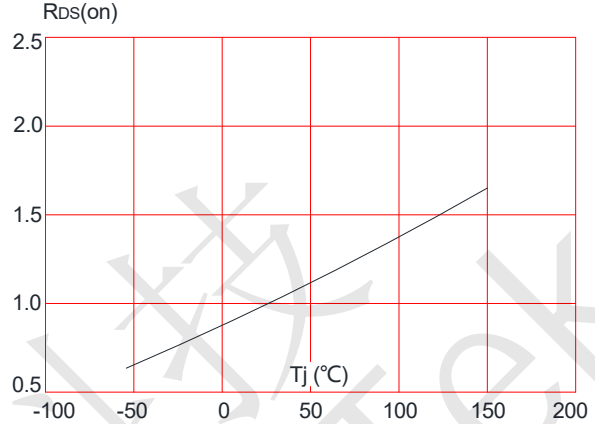


### CST4614 N-Ch and P-Ch Fast Switching MOSFETs

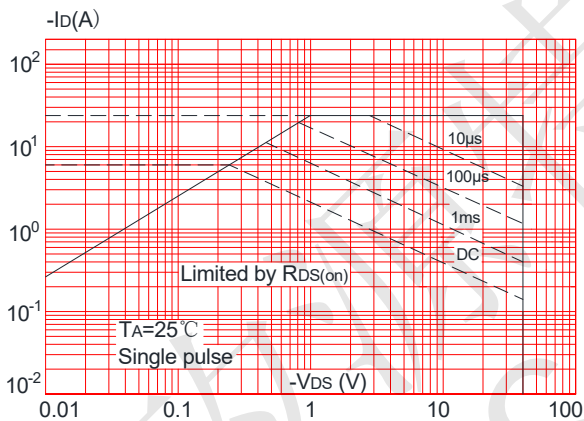
**Figure 7:** Normalized Breakdown Voltage vs. Junction Temperature



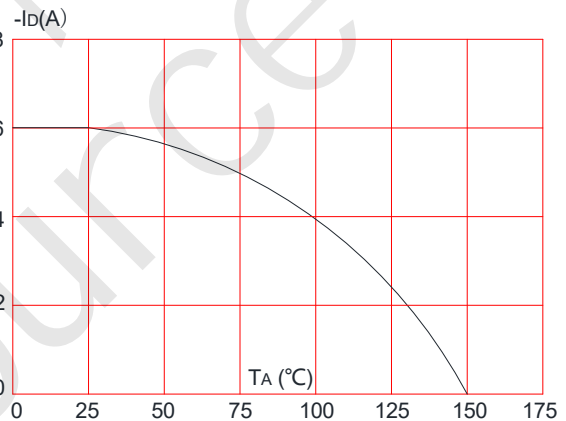
**Figure 8:** Normalized on Resistance vs. Junction Temperature



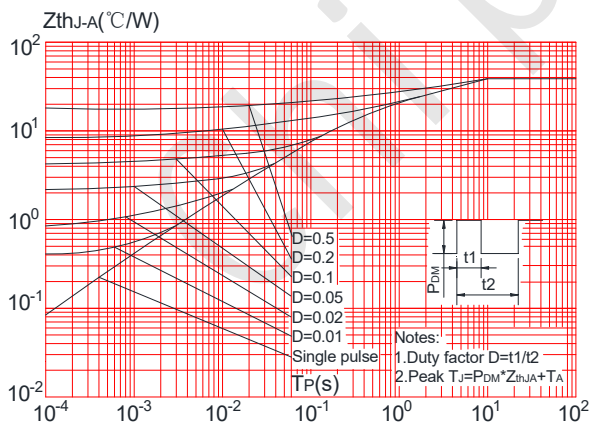
**Figure 9:** Maximum Safe Operating Area



**Figure 10:** Maximum Continuous Drain Current vs. Ambient Temperature

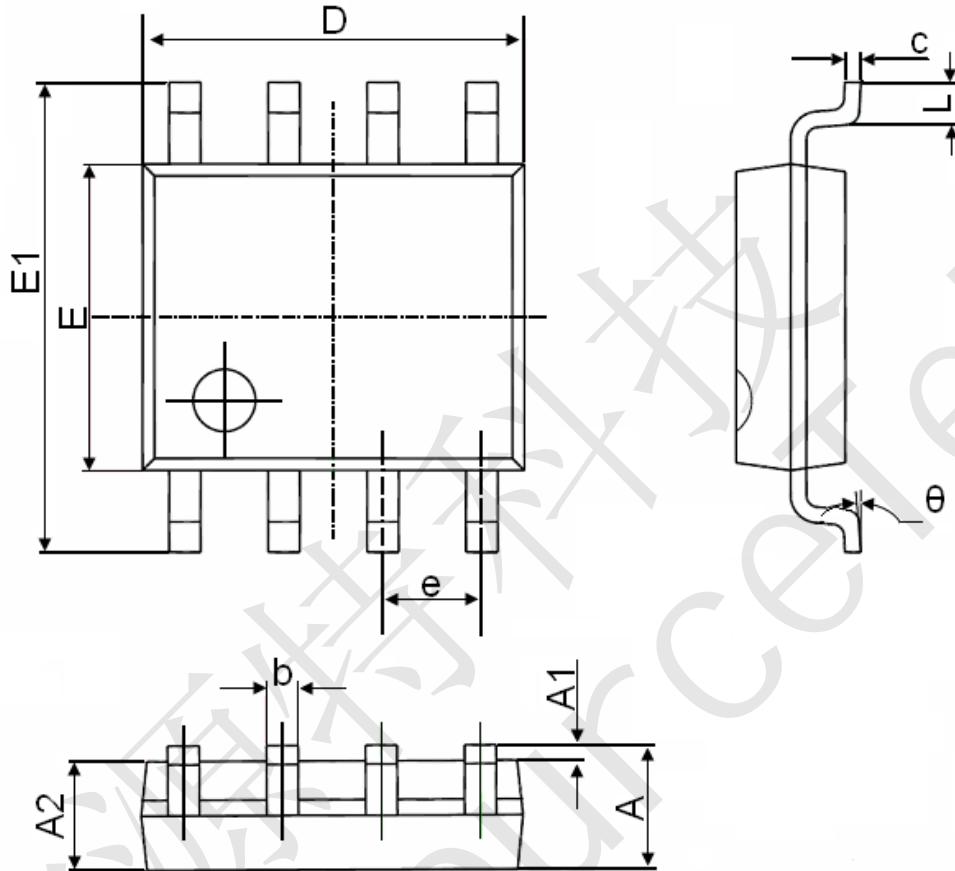


**Figure.11:** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient





CST4614 Package Mechanical Data- SOP-8



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°